

| Ref # | Hits   | Search Query                                                                     | DBs                                                               | Default Operator | Plurals | Time Stamp       |
|-------|--------|----------------------------------------------------------------------------------|-------------------------------------------------------------------|------------------|---------|------------------|
| L1    | 110420 | bt                                                                               | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2005/09/09 08:43 |
| L2    | 1837   | bismaleimide adj triazine                                                        | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2005/09/09 08:43 |
| L3    | 111149 | 1 2                                                                              | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2005/09/09 08:44 |
| L4    | 0      | "10613703"                                                                       | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2005/09/09 08:44 |
| L5    | 19     | "613703"                                                                         | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2005/09/09 08:44 |
| L6    | 1      | 2 and 5                                                                          | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2005/09/09 08:47 |
| L7    | 4364   | 3 with (substrate carrier board<br>((printed wiring circuit) adj4 board)<br>pcb) | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2005/09/09 08:47 |
| L8    | 1122   | (via hole opening) same 7                                                        | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2005/09/09 08:48 |

|     |     |                                                 |                                                                   |    |    |                  |
|-----|-----|-------------------------------------------------|-------------------------------------------------------------------|----|----|------------------|
| L9  | 380 | (bond bonding pad terminal electrode)<br>same 8 | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2005/09/09 08:48 |
| L10 | 203 | (photo land mask clearance)and 9                | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2005/09/09 08:49 |